



Dimensions	
Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	1.5mm MAX
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
K	1.3mm TYP

Packaging Specifications	
Packaging	T&R, 178mm
Packaging Quantity	1250

General Information	
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, Molded, Low Profile, Low ESR, Surge Robust
Features	Low Profile, Low ESR, Surge Robust
RoHS	Yes
Termination	Tin
AEC-Q200	No
Notes	Obsolete. Old Part Number [Obsolete] Was B45192R1227K409.

Specifications	
Capacitance	220 uF
Capacitance Tolerance	10%
Voltage DC	6.3 VDC (85C), 4.22 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	8%
Failure Rate	N/A
ESR	0.25 Ohms (100kHz)
Ripple Current	660 mAmps (25C), 594 mAmps (85C), 264 mAmps (125C)
Leakage Current	13.9 uA

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